

- [25] Saleh Al-Shehri, Hamed H. Saber, Experimental investigation of using thermoelectric cooling for computer chips, Journal of King Saud University – Engineering Sciences 2020;32:321 – 329. <https://doi.org/10.1016/j.jksues.2019.03.009>
- [26] Abdelillah A. Belarbi¹, M'hamed Beriache, Ahmed Bettahar, Experimental study of aero-thermal heat sink performances subjected to impinging air flow, International Journal of Heat and Technology 2018;36(4):1310 – 1317. <https://doi.org/10.18280/ijht.360420>
- [27] Gaurav Krishnayatra, Sulekh Tokas, Rajesh Kumar, Numerical heat transfer analysis & predicting thermal performance of fins for a novel heat exchanger using machine learning, Case Studies in Thermal Engineering 2020;21:100706. <https://doi.org/10.1016/j.csite.2020.100706>
- [28] Raghav Singupuram, Tabish Alam, Masood Ashraf Ali, Saboor Shaik, Naveen Kumar Gupta, Nevzat Akkurt, Mukesh Kumar, Sayed M. Eldin, Dan Dobrota, Numerical analysis of heat transfer and fluid flow in microchannel heat sinks for thermal management, Case Studies in Thermal Engineering 2023;45:102964. <https://doi.org/10.1016/j.csite.2023.102964>
- [29] J W Elliot, M T Lebon, A J Robinson, Optimising integrated heat spreaders with distributed heat transfer coefficients: A case study for CPU cooling, Case Studies in Thermal Engineering 2022;38:102354. <https://doi.org/10.1016/j.csite.2022.102354>

